2SB1434

Silicon PNP epitaxial planer type

For low-frequency output amplification Complementary to 2SD2177

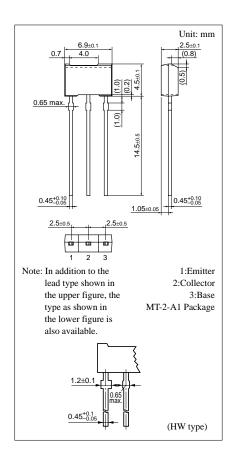
Features

- Low collector to emitter saturation voltage V_{CE(sat)}.
- Allowing supply with the radial taping.

Absolute Maximum Ratings (Ta=25°C)

| Parameter | Symbol | Ratings | Unit |
|------------------------------|----------------|-------------------|------|
| Collector to base voltage | V_{CBO} | -50 | V |
| Collector to emitter voltage | V_{CEO} | -50 | V |
| Emitter to base voltage | $V_{\rm EBO}$ | -5 | V |
| Peak collector current | I_{CP} | -3 | A |
| Collector current | I_{C} | -2 | A |
| Collector power dissipation | ${P_C}^*$ | 1 | W |
| Junction temperature | T _j | 150 | °C |
| Storage temperature | T_{stg} | −55 ~ +150 | °C |

 $^{^{\}ast}$ Printed circuit board: Copper foil area of 1cm² or more, and the board thickness of 1.7mm for the collector portion



Electrical Characteristics (Ta=25°C)

| Parameter | Symbol | Conditions | min | typ | max | Unit |
|---|----------------------|--|-----|--------|-------|------|
| Collector cutoff current | I_{CBO} | $V_{CB} = -20V, I_E = 0$ | | | - 0.1 | μА |
| Collector to base voltage | V _{CBO} | $I_{\rm C} = -10\mu{\rm A}, I_{\rm E} = 0$ | -50 | | | V |
| Collector to emitter voltage | V _{CEO} | $I_{C} = -1 \text{mA}, I_{B} = 0$ | -50 | | | V |
| Emitter to base voltage | V _{EBO} | $I_{\rm E} = -10 \mu A, I_{\rm C} = 0$ | -5 | | | V |
| | h _{FE1} *1 | $V_{CE} = -2V, I_{C} = -200 \text{mA}$ | 120 | | 340 | |
| Forward current transfer ratio | h _{FE2} | $V_{CE} = -2V, I_{C} = -1A^{*2}$ | 60 | | | |
| Collector to emitter saturation voltage | V _{CE(sat)} | $I_C = -1A, I_B = -50 \text{mA}^{*2}$ | | - 0.2 | - 0.3 | V |
| Base to emitter saturation voltage | V _{BE(sat)} | $I_C = -1A, I_B = -50 \text{mA}^{*2}$ | | - 0.85 | -1.2 | V |
| Transition frequency | f_T | $V_{CB} = -10V$, $I_E = 50$ mA, $f = 200$ MHz | | 110 | | MHz |
| Collector output capacitance | C _{ob} | $V_{CB} = -10V, I_E = 0, f = 1MHz$ | | 40 | 60 | pF |

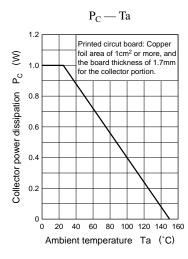
^{*2} Pulse measurement

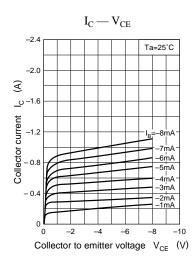
^{*1}hFE1 Rank classification

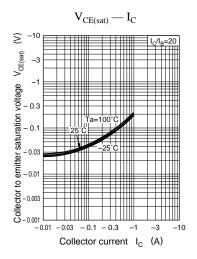
| Rank | R | S |
|------------------|-----------|-----------|
| h _{FE1} | 120 ~ 240 | 170 ~ 340 |

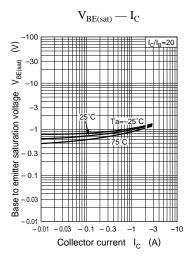
264 Panasonic

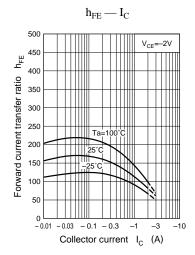
Transistor 2SB1434

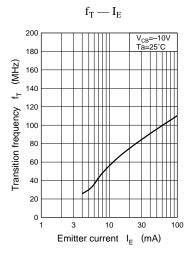


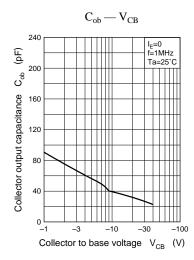












Panasonic 265

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